

Antenna

YC0001AA Datasheet

Antenna Services

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Status: Released



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About the Document

Revision History

Version	Date	Author	Note
1.0	2020-05-28	Kenny YIN	Initial
2.0	2020-06-22	Kenny YIN	Updated the specifications.
2.1	2020-12-11	Kenny YIN	Updated the antenna image in Chapter 2.
2.2	2021-01-27	Kenny YIN	Added return loss data, pattern laboratory pictures, package parameters.

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1 Product Description

The antenna is designed for superior performance, and can be widely used for wireless applications.

We provide comprehensive antenna design support such as simulation, testing and manufacturing for custom antenna solutions to meet your specific application needs.

2 Product Features

- Cellular LTE
- High efficiency
- Excellent performance



3 Product Specifications

Passive Electrical Specifications

Frequency Range	698–960 MHz, 1710–2690 MHz
Input Impedance	50 Ω
VSWR	≤ 4.0
Gain	≤ 3.0 dBi
Polarization Type	Linear

Mechanical Specifications

Antenna Size	35.0 mm (L) \times 8.5 mm (W) \times 3.0 mm (H)
Carrier	FR4
Connector Type	SMD
Working Temperature	-40 $^{\circ}$ C to +85 $^{\circ}$ C
Radome Color	Black

4 Overall Performance

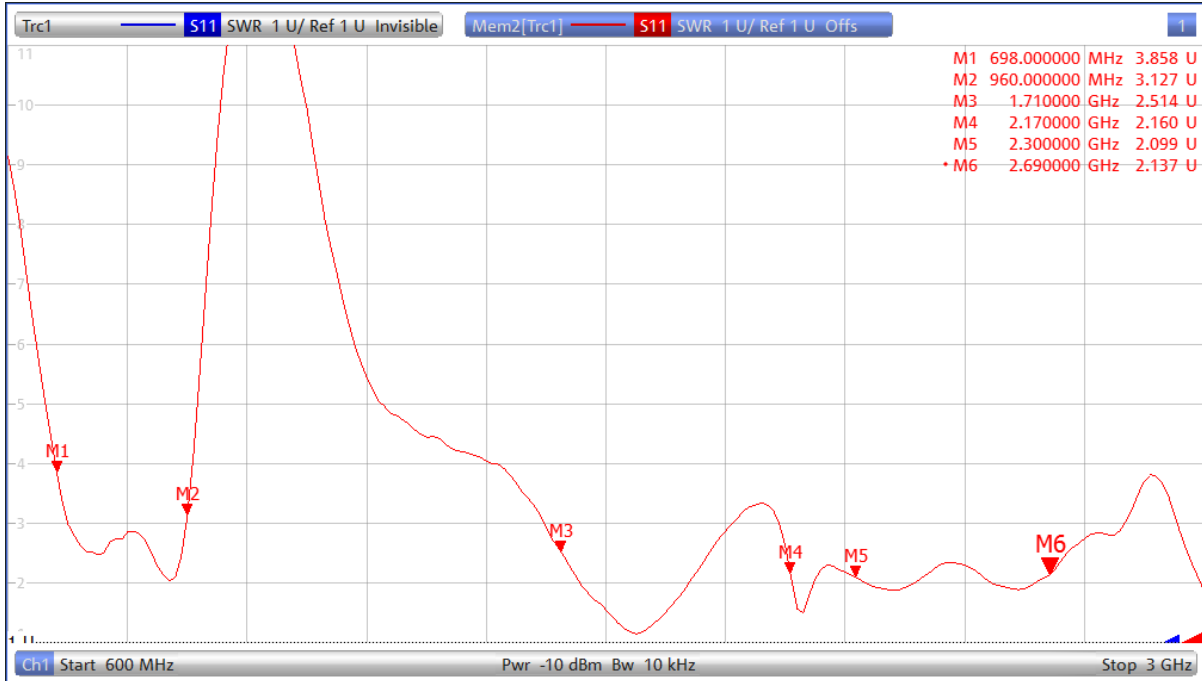
4.1. Test Environment

- KEYSIGHT VNA Network Analyzer E5063A 100 kHz – 6.5 GHz.
- RayZone®2800 Chamber 5G (FR1) SISO/MIMO, 400 MHz – 6.0 GHz.



4.2 VSWR

Board length 110 mm



Frequency (MHz)	698	960	1710	2170	2300	2690
VSWR	3.85	3.12	2.51	2.16	2.09	2.13

4.3 Return Loss

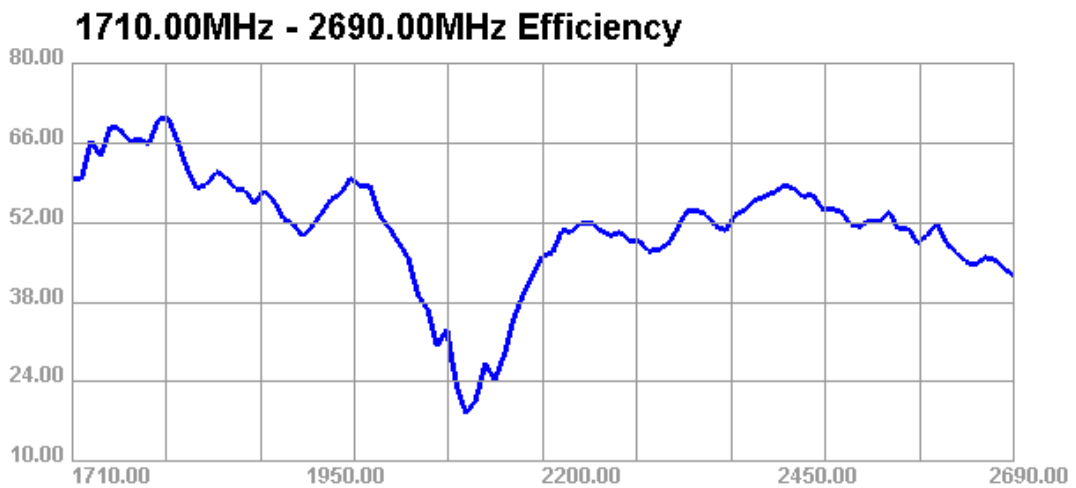
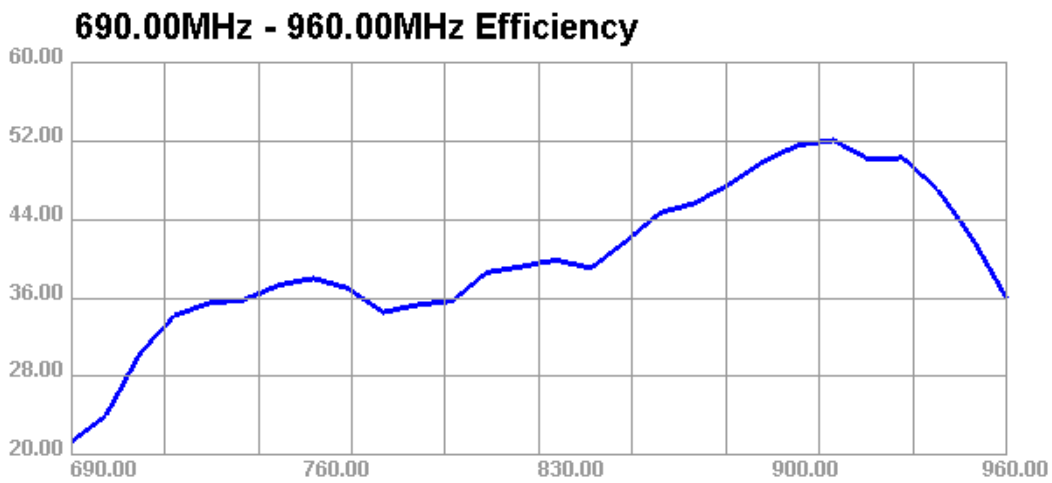
Board length 110 mm



Frequency (MHz)	698	960	1710	2170	2300	2690
Return Loss	-4.54	-4.99	-13.12	-6.50	-14.55	-9.46

4.4 Efficiency

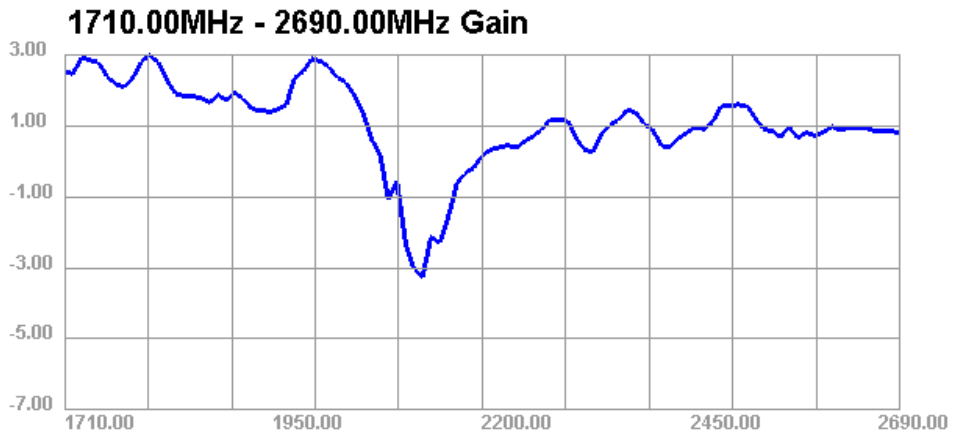
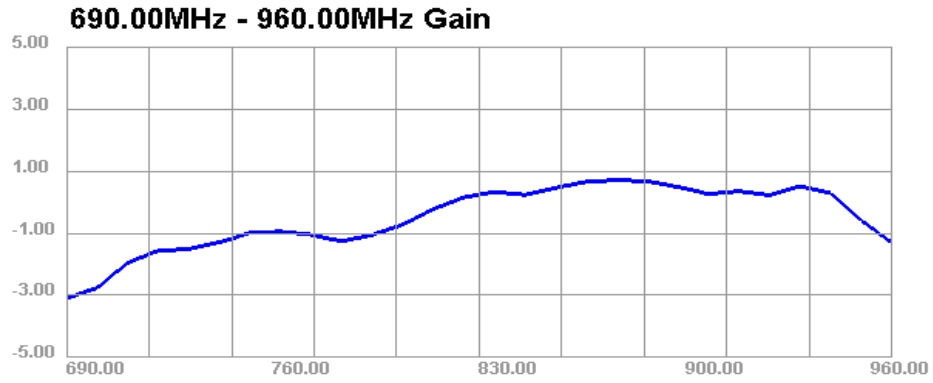
Board length 110 mm



Frequency (MHz)	698	960	1710	2170	2300	2690
Efficiency (%)	21.4	36.0	59.8	35.3	48.8	42.7

4.5 Gain

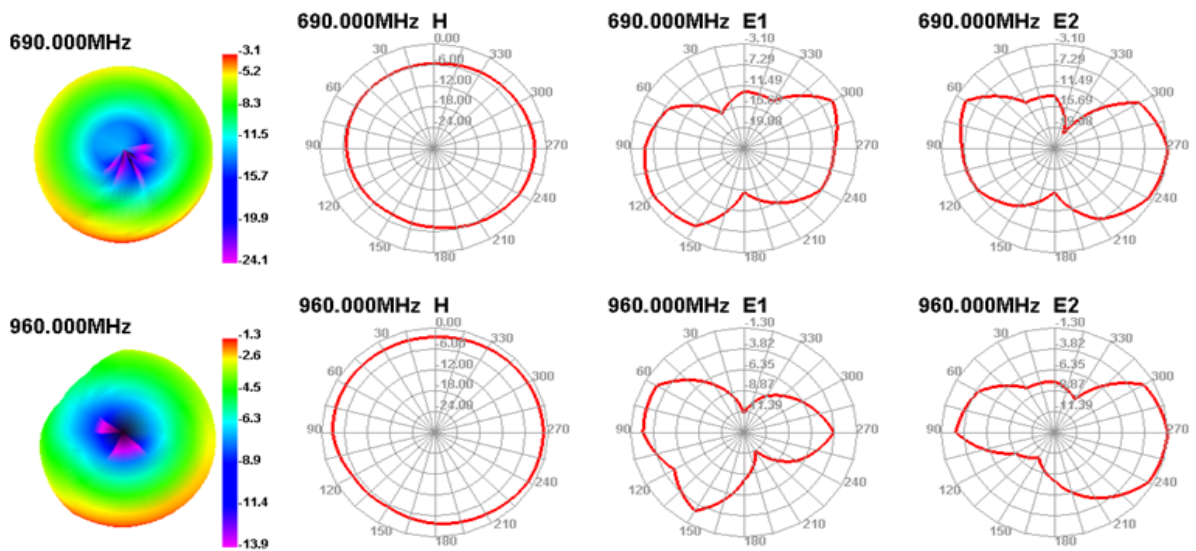
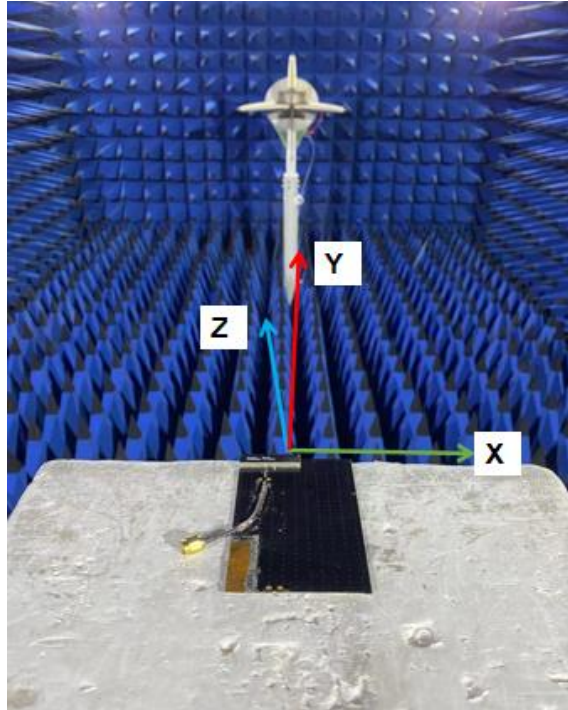
Board length 110 mm



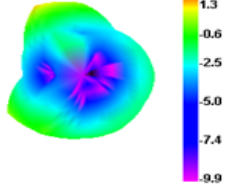
Frequency (MHz)	698	960	1710	2170	2300	2690
Gain	-2.73	-1.20	1.97	-1.54	1.33	0.95

4.6 Radiation Patterns

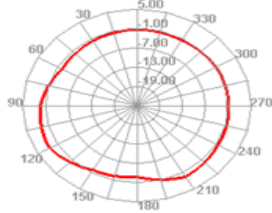
Board length 110 mm



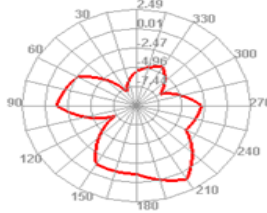
1710.000MHz



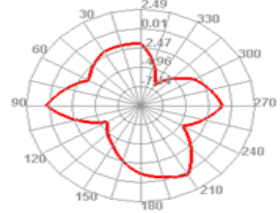
1710.000MHz H



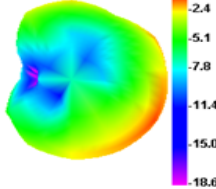
1710.000MHz E1



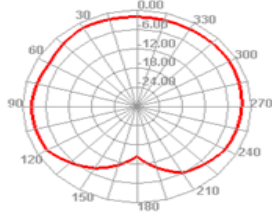
1710.000MHz E2



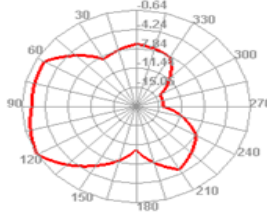
2170.000MHz



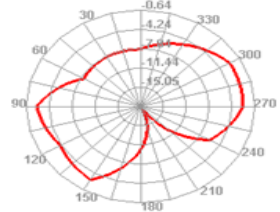
2170.000MHz H



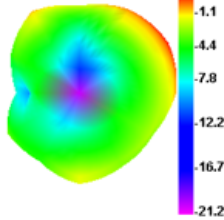
2170.000MHz E1



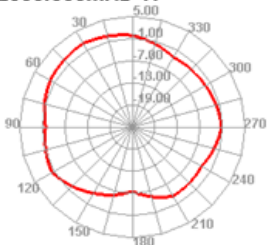
2170.000MHz E2



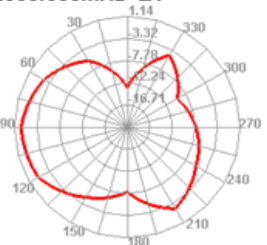
2300.000MHz



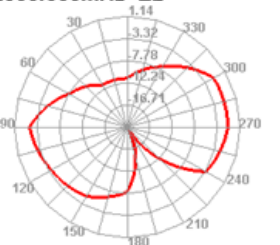
2300.000MHz H



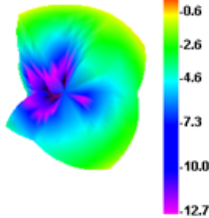
2300.000MHz E1



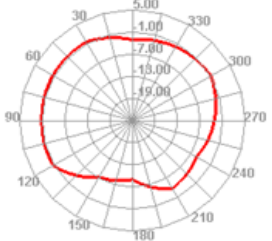
2300.000MHz E2



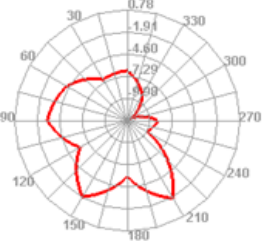
2690.000MHz



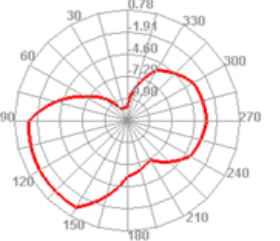
2690.000MHz H



2690.000MHz E1

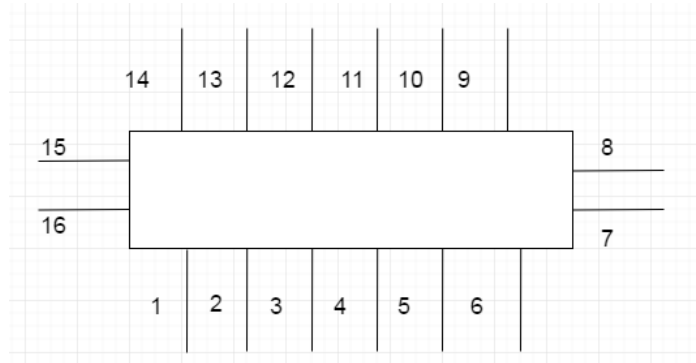


2690.000MHz E2



5 Schematic Symbol and Pin Definition

The pin assignment for the antenna is as follows. The antenna has 16 pins and only two work. All other pins are designed for mechanical strength.

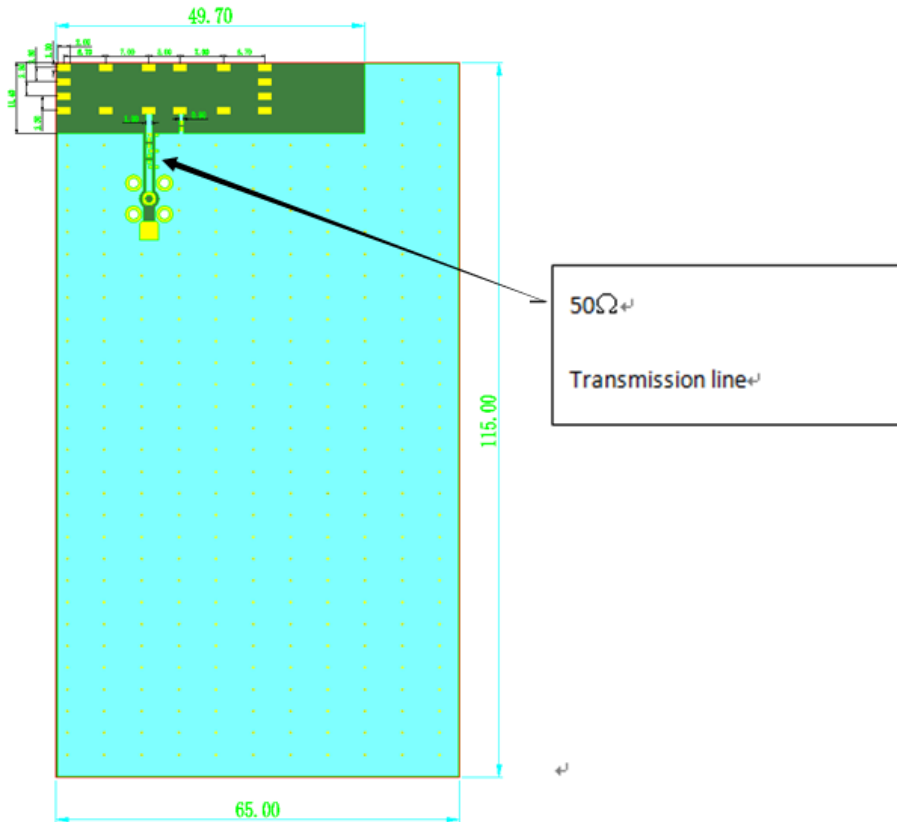


Pin No.	Description
3	Feed
4	Return/GND
1, 2, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16	Not used (Mechanical only)

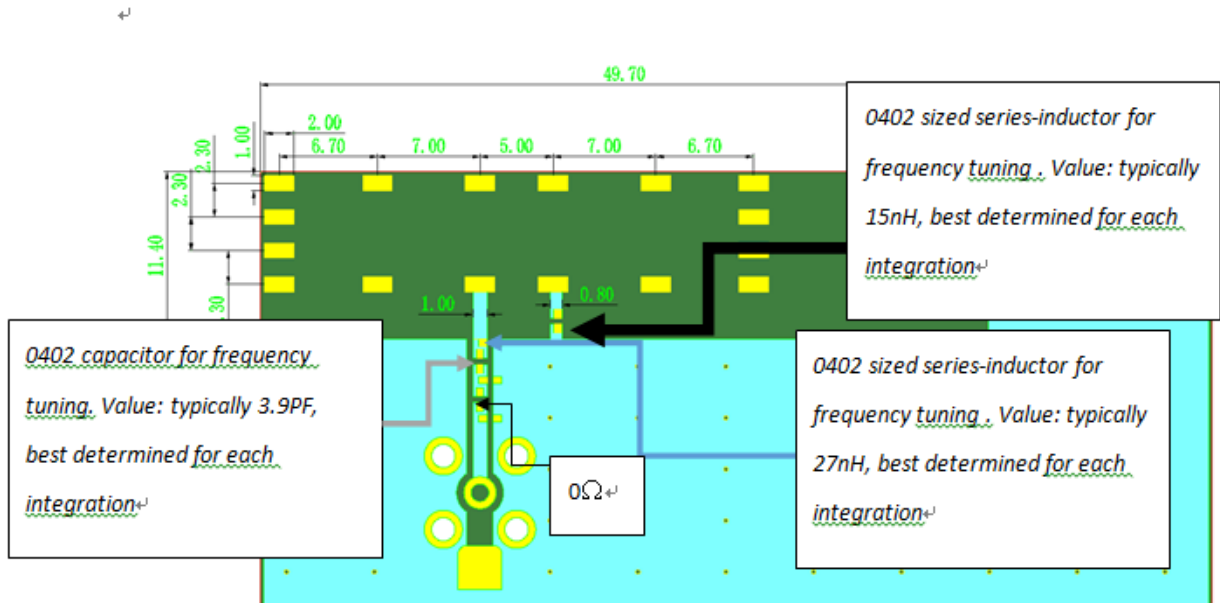
6 Transmission Line

The characteristic impedance of all transmission lines shall be designed as 50 Ω .

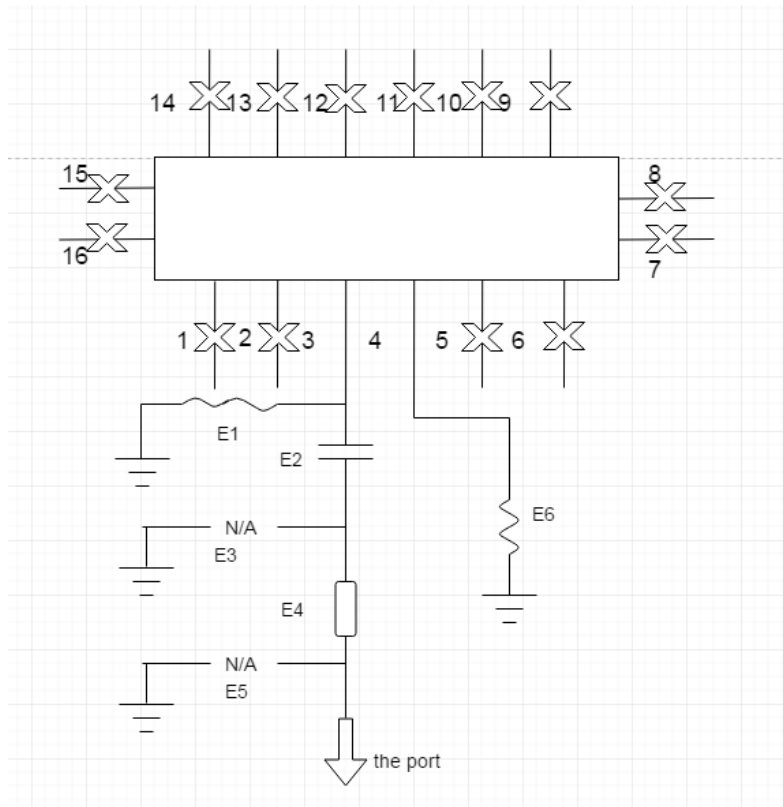
- The length of the transmission lines should be kept to as short as possible.
- Any other part of the RF system, such as transceiver, power amplifiers, etc., shall also be designed with an impedance of 50 Ω .



7 Matching Circuit



The antenna requires a matching circuit that must be optimized for each product. The matching circuit will require up to six components and the following circuit should be designed into the host PCB. Not all components may be required but should be included as a precaution. The matching network must be placed close to the antenna feed to ensure it is more effective in tuning the antenna.

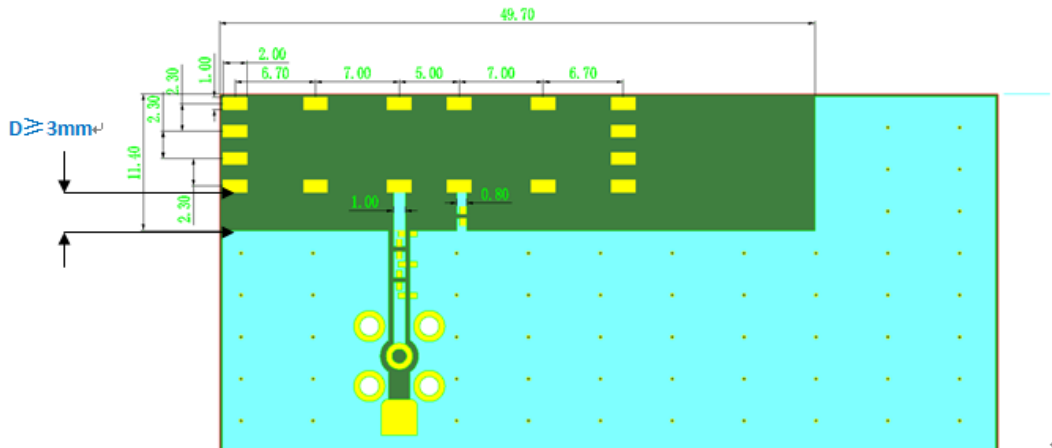


	Type	Value
E1	Inductor	27 nH
E2	Capacitor	3.9 pF
E3	N/A	N/A
E4	Capacitance	0 Ω
E5	N/A	N/A
E6	Inductor	15 nH

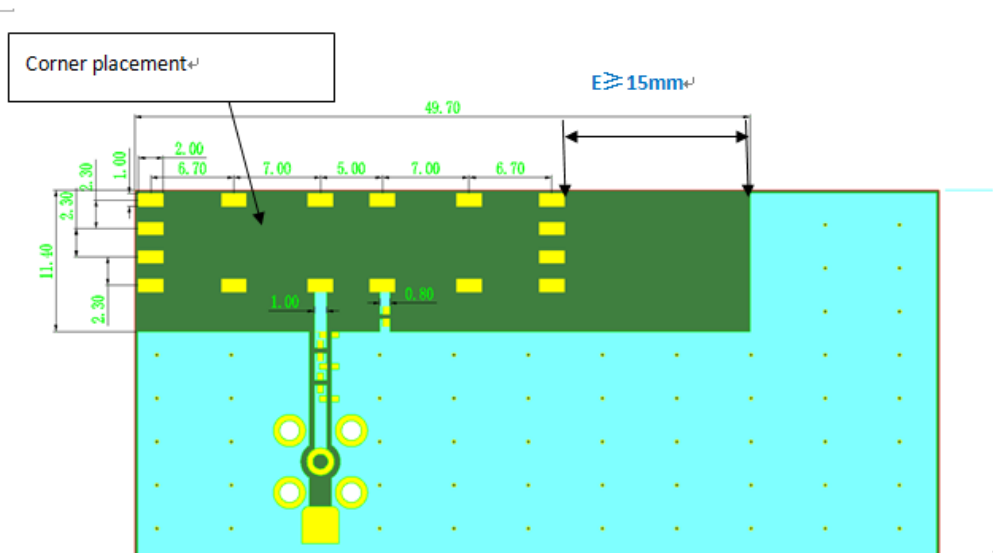
8 Host PCB Requirement

The printed circuit board of the host must ensure that the antenna clearance area meets the antenna specifications. It is suggested that putting the antenna in the corner of the PCB.

An example of a PCB layout shown as below:



Gap D is required from the edge of the antenna to the ground plane. This should be maintained along the edge of the antenna placement, **minimum value is 3 mm**.

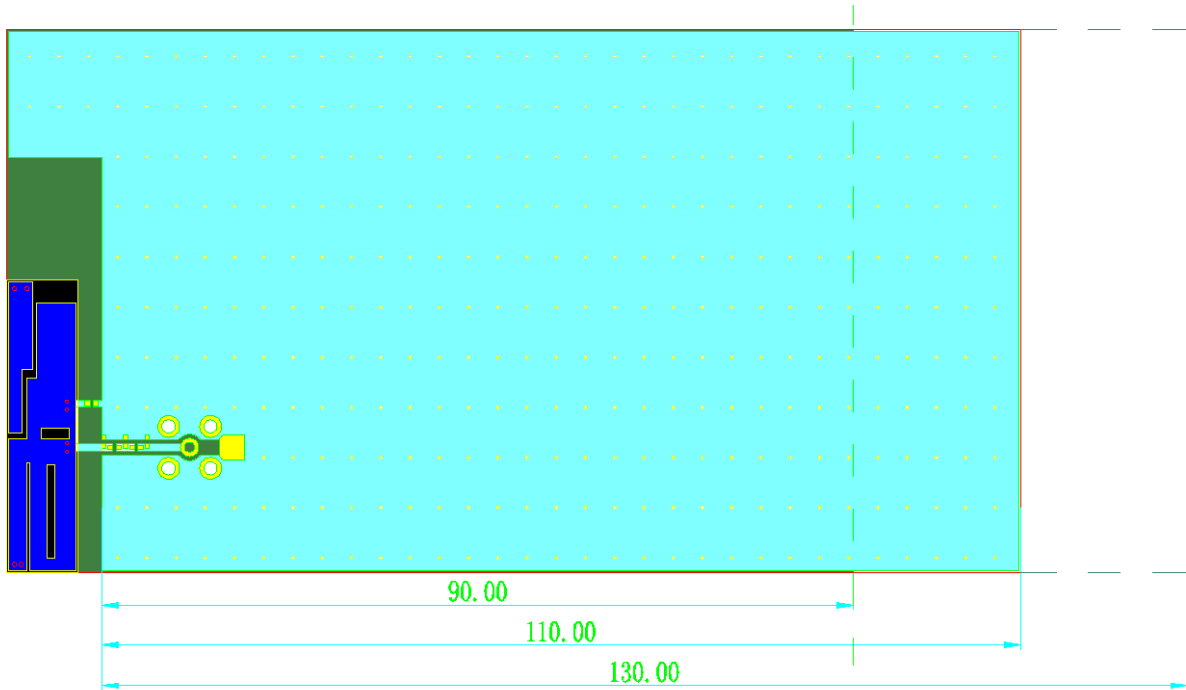


Gap E is required from the edge of the antenna to the ground plane or PCB traces, **minimum value is 15 mm**.

8.1. Host PCB Size

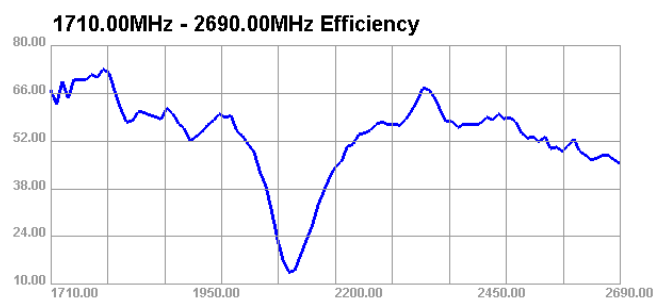
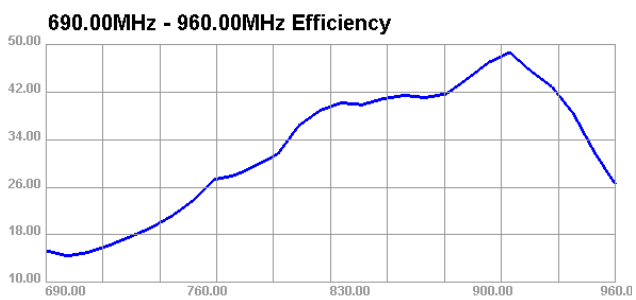
The performance of the low frequency section depends on the length of the ground plane. Reducing GND length will directly impact on the performance of low frequency band.

Taking antenna efficiency measurement results on different GND sizes as an example:

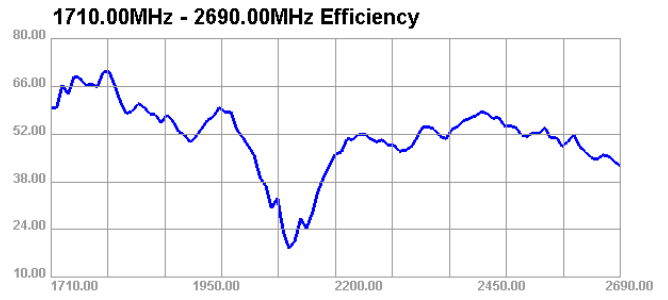
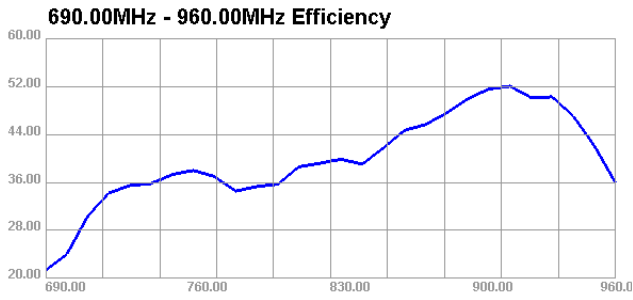


Passive Efficiency vs. PCB length
All results measured in Quectel's anechoic chamber

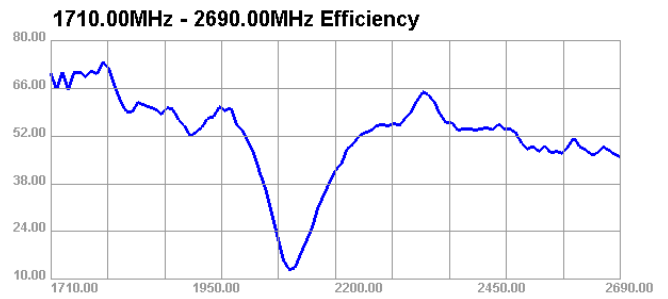
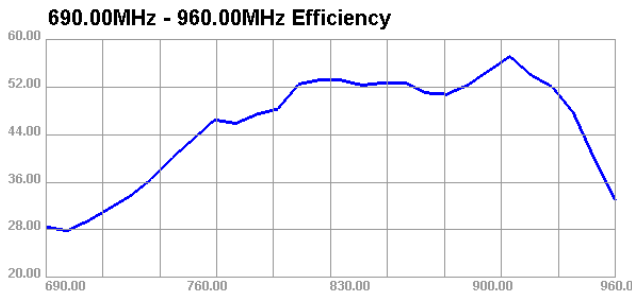
- Board length 90 mm



● Board length 110mm



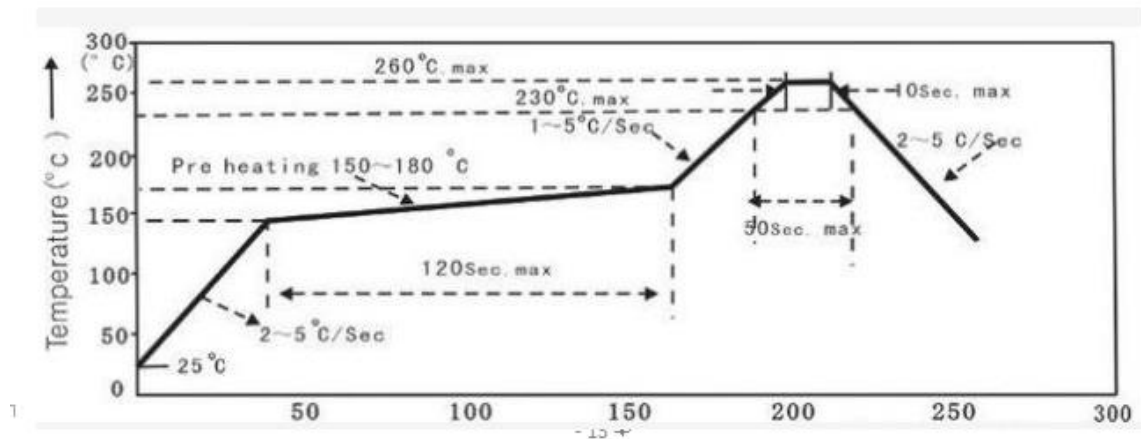
● Board length 130 mm



9 Soldering Temperature

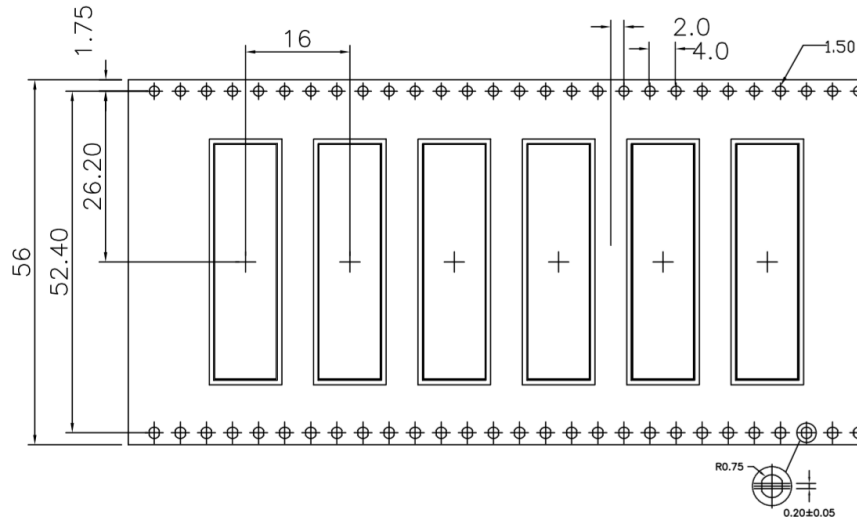
Phase	Profile Features	PB-Free Assembly (Max.)
RAMP-UP	Avg. Ramp-up Rate (T _{smax} to T _p)	3 °C/second (max.)
PREHEAT	Temperature Min. (T _{smin})	150 °C
	Temperature Max. (T _{smax})	180 °C
	Time (T _{smin} to T _{smax})	120 seconds max.
REFLOW	Temperature (T _L)	210 °C
	Total Time above T _L (t _l)	50 seconds max.
PEAK	Temperature (T _p)	260 °C
	Time (t _p)	10 seconds max.
RAMP-DOWN	Rate	5 °C/second max.

10 Reflow Profile

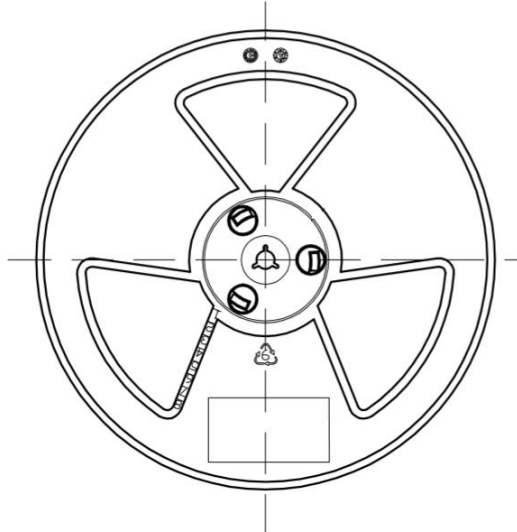


11 Package

- Quantity/Reel: 1000 pcs/Reel
- Carrier tape dimensions (mm)

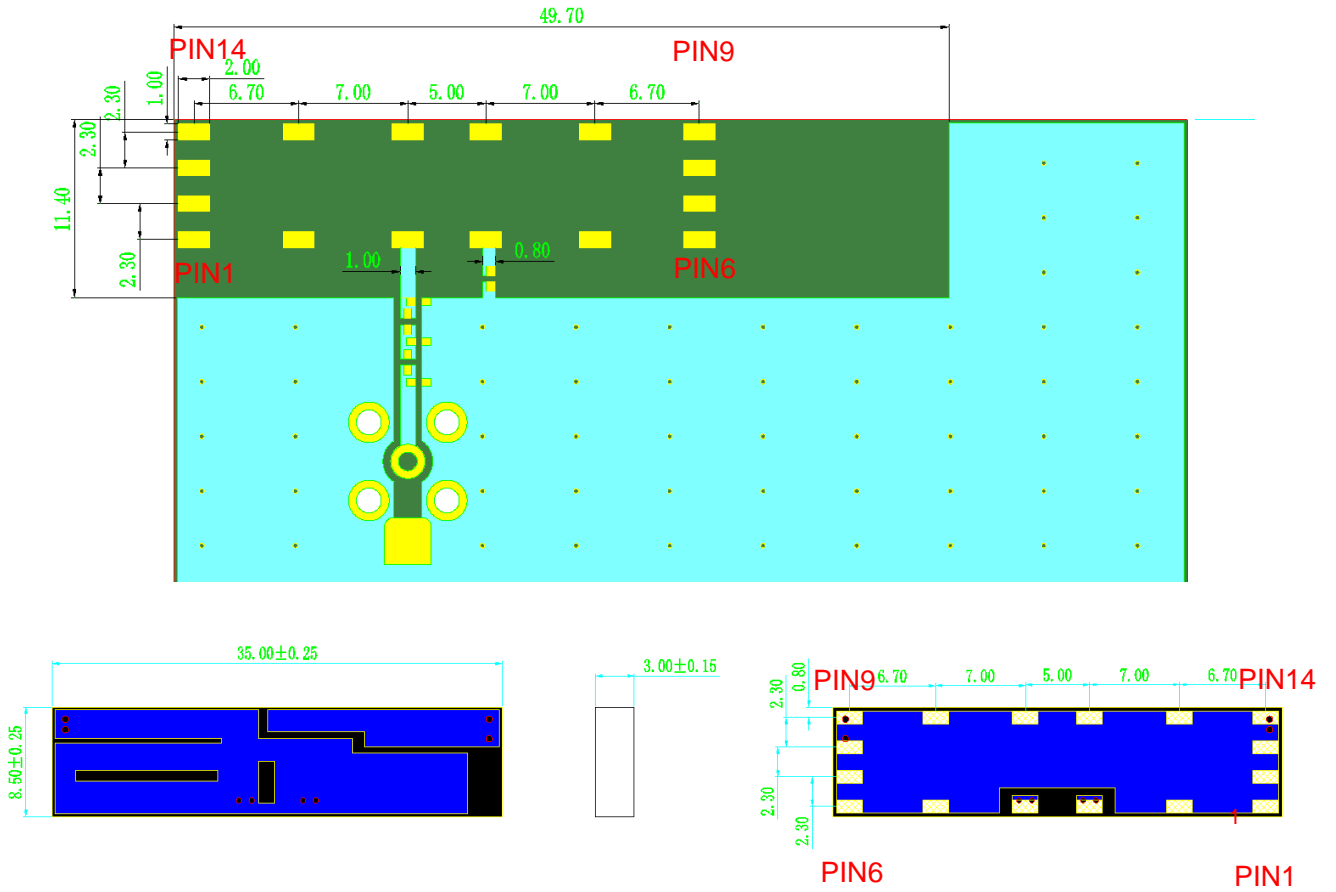


- Taping reel dimensions (mm)



330 mm x 100 mm x 56.4 mm

12 Product Size



Please contact us for any unmarked size information.